



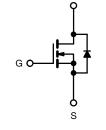
Q_{gd} (nC)

Configuration

D Series Power MOSFET

PRODUCT SUMMARY					
V_{DS} (V) at T_J max.	550)			
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 1.				
Q _g max. (nC)	20				
Q _{qs} (nC)	3				

DPAK (TO-252)	
GS	



5

Single

N-Channel MOSFET

D

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (C_{iss})
 - Reduced capacitive switching lossesHigh body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): $R_{\text{on}} \mathrel{x} Q_{\text{g}}$
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
- Motor drives
- Battery chargers

ORDERING INFORMATION				
Package	DPAK (TO-252)			
Lead (Pb)-free	SiHD5N50D-E3			
Lead (Pb)-free and Halogen-free	SiHD5N50D-GE3			
	SiHD5N50DT1-GE3			
	SiHD5N50DT4-GE3			
	SiHD5N50DT5-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	500			
Gate-Source Voltage		N/	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	V _{GS}	30			
Continuous Drain Current ($T_{\rm c} = 150$ °C)	$V_{GS} \text{ at } 10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	I.,	5.3		
Continuous Drain Current (T _J = 150 °C)	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	3.4	А	
Pulsed Drain Current ^a	I _{DM}	10			
Linear Derating Factor		0.83	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	28.8	mJ		
Maximum Power Dissipation	PD	104	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	dV/dt	24	V/ns		
Reverse Diode dV/dt ^d		0.28	v/ns		
Soldering Recommendations (Peak temperature) ^c		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 $\Omega,\,I_{AS}$ = 5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, starting $T_J = 25$ °C.

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.2	0/W	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zero Gate Voltage Drain Current		V _{DS} =	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	1	
Zero Gale Voltage Drain Gurrent	I _{DSS}	V _{DS} = 400 V	∕, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 2.5 A	-	1.2	1.5	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} :	= 20 V, I _D = 2.5 A	-	1.8	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	325	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	34	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	31	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	41	-	
Total Gate Charge	Qg		V _{GS} = 10 V I _D = 2.5 A, V _{DS} = 400 V		10	20	
Gate-Source Charge	Q_gs	$V_{GS} = 10 V$			3	-	nC
Gate-Drain Charge	Q_gd			-	5	-	
Turn-On Delay Time	t _{d(on)}			-	12	24	ns
Rise Time	t _r	V _{DD} =	= 400 V, I _D = 2.5 A	-	11	22	
Turn-Off Delay Time	t _{d(off)}	R _g =	$R_{g} = 9.1 \Omega, V_{GS} = 10 V$		14	28	115
Fall Time	t _f				11	22	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.7	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	5	
Pulsed Diode Forward Current	I _{SM}			-	-	20	A
Diode Forward Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 4 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	320	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 2.5 \text{ A},$ dl/dt = 100 A/µs, V _R = 20 V		-	1.2	-	μC
Reverse Recovery Current	I _{RRM}			-	8	-	Α

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

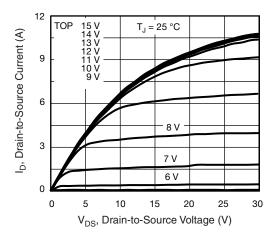


Fig. 1 - Typical Output Characteristics

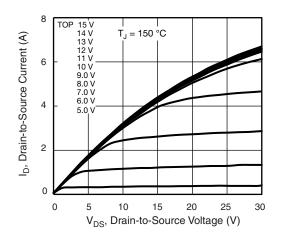


Fig. 2 - Typical Output Characteristics

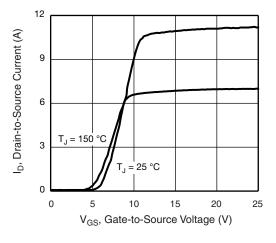


Fig. 3 - Typical Transfer Characteristics

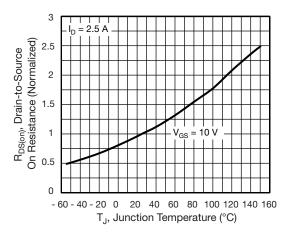


Fig. 4 - Normalized On-Resistance vs. Temperature

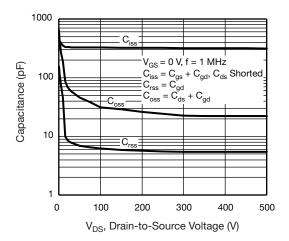


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

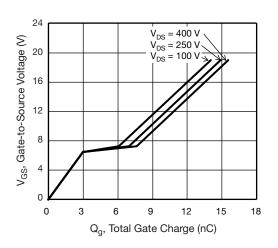


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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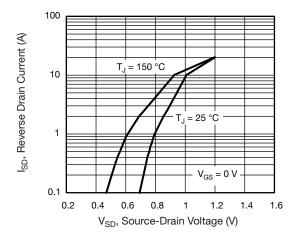


Fig. 7 - Typical Source-Drain Diode Forward Voltage

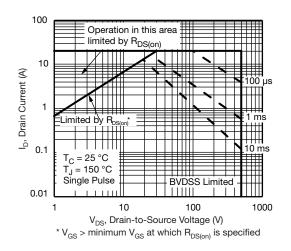


Fig. 8 - Maximum Safe Operating Area

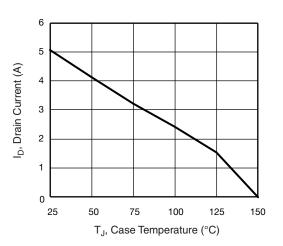


Fig. 9 - Maximum Drain Current vs. Case Temperature

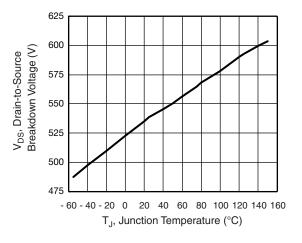
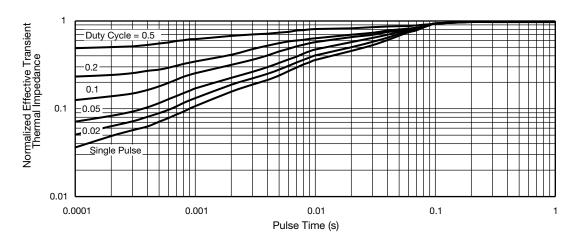


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





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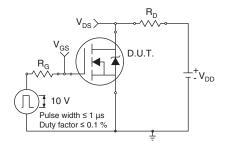


Fig. 12 - Switching Time Test Circuit

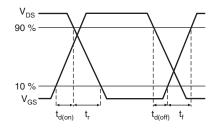


Fig. 13 - Switching Time Waveforms

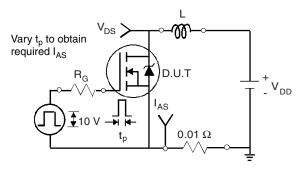


Fig. 14 - Unclamped Inductive Test Circuit

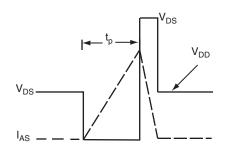


Fig. 15 - Unclamped Inductive Waveforms

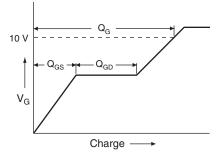


Fig. 16 - Basic Gate Charge Waveform

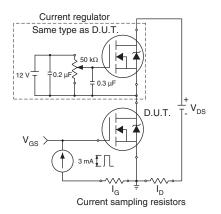
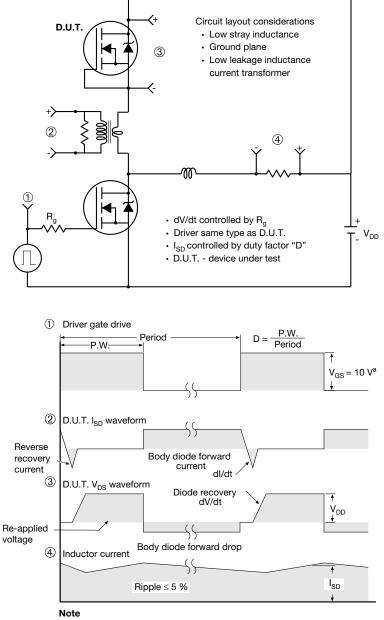


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit

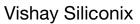


a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

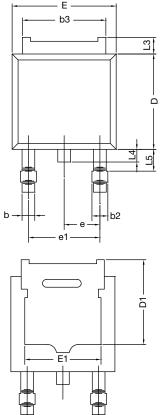
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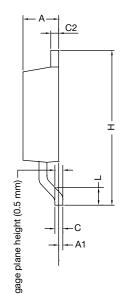
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TO-252AA Case Outline





	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	4.10	-	0.161	-		
Е	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28 BSC		0.090 BSC			
e1	4.56 BSC		0.180 BSC			
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.01	1.52	0.040	0.060		
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347						

Notes

• Dimension L3 is for reference only.



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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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